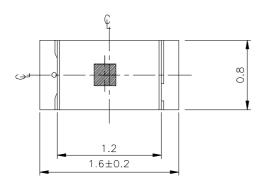
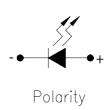
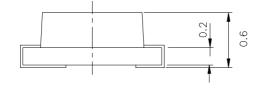


19-213/Y2C-AP1Q2B/3T

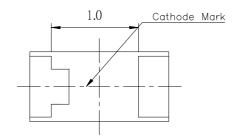
Package Outline Dimensions

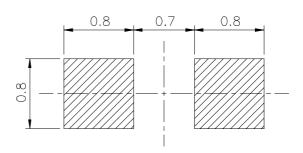






For reflow soldering (Propose)





Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd.

Device No.: DSE-0001310

http://www.everlight.com

Prepared date:15-Apr-2009

Rev.1 Page: 2 of 10

Prepared by: Huang yongxin



19-213/Y2C-AP1Q2B/3T

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_F	25	mA	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	45.0		112	mcd	
Peak Wavelength	λр		591		nm	
Dominant Wavelength	λd	585.5		594.5	nm	
Spectrum Radiation Bandwidth	Δλ		15		nm	IF =20mA
Viewing Angle	2 \theta 1/2		120		deg	
Forward Voltage	VF	1.75		2.35	V	
Reverse Current	Ir			10	μ A	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10



19-213/Y2C-AP1Q2B/3T

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A	D3	585.5	588.5		I _F =20mA
	D4	588.5	591.5	nm	
	D5	591.5	594.5		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
P1	45.0	57.0		
P2	57.0	72.0	mcd	IF =20mA
Q1	72.0	90.0		
Q2	90.0	112.0		

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	$I_F=20mA$
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

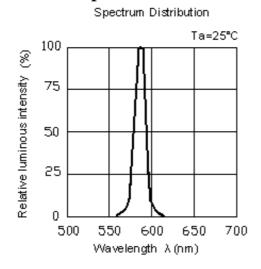
3.Tolerance of Forward Voltage ±0.1V

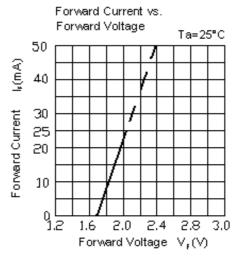
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10

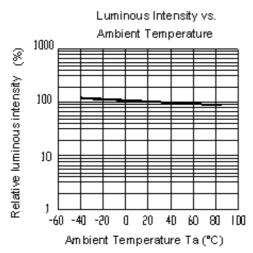


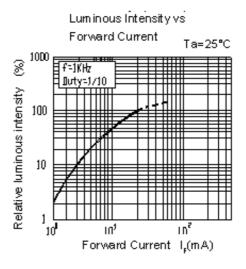
19-213/Y2C-AP1Q2B/3T

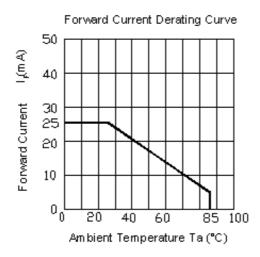
Typical Electro-Optical Characteristics Curves

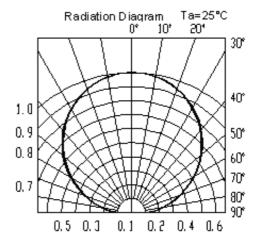












Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 10



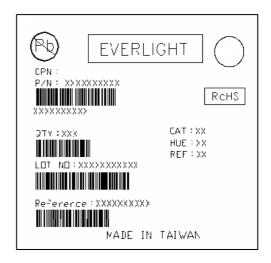
19-213/Y2C-AP1Q2B/3T

Label explanation

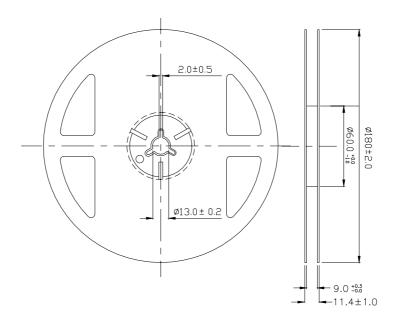
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



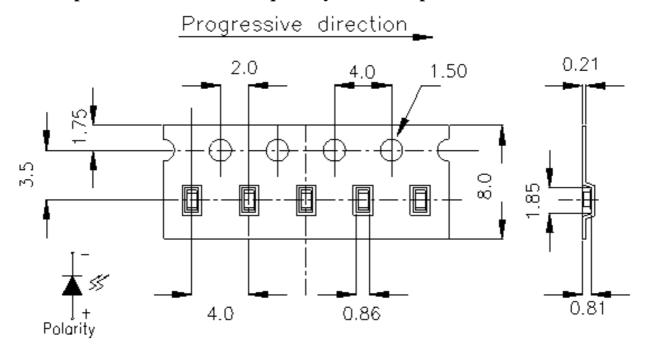
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 6 of 10



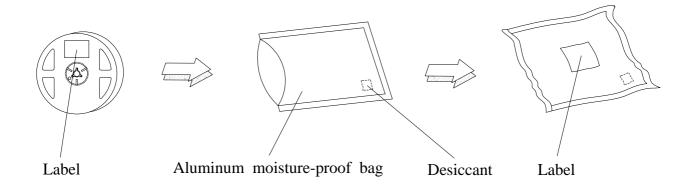
19-213/Y2C-AP1Q2B/3T

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd.

Device No.: DSE-0001310

http://www.everlight.com

Prepared date:15-Apr-2009

Rev.1 Page: 7 of 10

Prepared by: Huang yongxin



19-213/Y2C-AP1Q2B/3T

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition Test Hours/Cyc		Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10



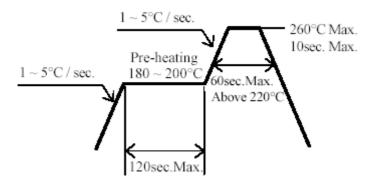
19-213/Y2C-AP1Q2B/3T

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 10



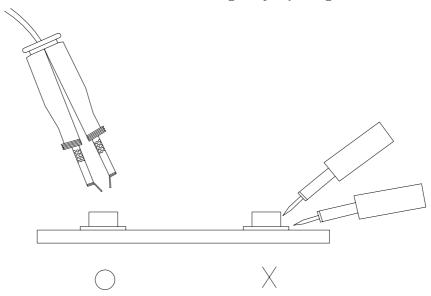
19-213/Y2C-AP1Q2B/3T

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10

Device No.: DSE-0001310 Prepared date:15-Apr-2009 Prepared by: Huang yongxin